

Message from the organizers

Dear Colleagues and Friends,

We would like to invite all of you to join the 2020 International Interdisciplinary Conference on Materials Science & Engineering and Computational Information Technology, which will be held online and offline simultaneously, during Aug 29-31 2020.

The conference is intended to serve as an interdisciplinary platform for the exchange and networking between top scientists, experienced engineers, frontier

researchers, and students across a wide spectrum of research fields.

Your active participation and discussion is the key to the success of this conference.



Yours Sincerely,

Organizing Committee

2020 International Interdisciplinary Conference on Materials Science & Computational Informatics

APSMR 2020 Annual Meeting / APSCIT 2020 Annual Meeting



Conference organizing committee

CONFERENCE CHAIRS

Prof. Shigeo AKASHI (Tokyo University of Science)

Prof. Shih-Chieh HSU (Tamkang University)

Prof. Chia-Cheng LIN (Shin Kong Wu Ho-Su Memorial Hospital)

Dr. Yingxue SONG (Beihang University)

Prof. Yung-Kang SHEN (Taipei Medical University)

CONFERENCE PROGRAM DIRECTORS

Dr. Yingxue SONG

CONFERENCE SECRETARIAT

Ms. Yaru WU (APSMR)

Ms. Alexis CHUNG (APSCIT)



Conference topics

MATERIALS SCIENCE & ENGINEERING:

- 1. Structure materials and Functional Coatings (metals, ceramics, and composites)
- 2. Materials for energy (saving, conversion, transfer, storage) and environment plus electrochemistry
 - 2.1. Photovoltaics
 - 2.2. Batteries and Fuel Cells
 - 2.3. Materials for Thermal Management and Thermal Energy Utilization
 - 2.4. Materials for Energy and Environmental Applications
- 3. Optics and Photonic Materials
- 4. Electronic, Magnetic and Nanomaterials
- 5. Polymer Science and Molecular Chemistry
- 6. Organic Materials and Bio-materials
- 7. Materials Characterization and Computational Modeling

COMPUTATION AND IT:

- 1: Theory, Algorithms, Programming
- 2: Database, Cloud Computing, Data Mining, Big Data
- 3: Communications, Networking, Security, and Internet of Things
- 4: Multimedia, Image Processing and Recognition (Virtual Reality)
- 5: High Performance Computing and Intelligent Systems (AI, Robotics)
- 6: Software Engineering and Applications
- 7: Electronics (Analog/Digital Circuits, Signal Processing, System Architectures)

Beijing/Taipei	Tokyo	SAT, 08/29	SUN, 08/30	MON, 08/31
9:00 – 10:15	10:00 – 11:15		Oral Presentation	
10:15 – 10:30	11:15 – 11:30		Coffee & Tea Break	
10:30 – 12:00	11:30 – 13:00		Oral Presentation	
12:10 – 13:00	13:10 – 14:00		Lunch Break	
13:00 – 14:30	14:00 – 15:30	Pre-session technical and discussion forums on international collaboration (by invitation only)	Oral Presentation	
14:30 – 14:45	15:30 – 15:45		Coffee & Tea Break	
14:45 – 15:30	15:45 – 16:30		Oral Presentation	
15:30 – 17:00	16:30 – 18:00			
16:30 – 19:30	17:30 – 20:30	Conference Registration		



Presentation List

Beijing/Taipei	Tokyo	SAT, 08/29	SUN, 08/30	MON, 08/31
9:00 – 10:15	10:00 – 11:15		1. R. WU 2. C.L. LIN	13. S.C. HSU, S.W. LUO 14. D. ZHAO*
10:15 – 10:30	11:15 – 11:30	Coffee & Tea Break		
10:30 – 12:00	11:30 – 13:00		3. K. KATSURADA*† 4. Y.J. WU 5. H. WANG*	15. S.H. CAI 16. G.S. WU 17. Z.H. XIE
12:10 – 13:00	13:10 - 14:00		Lunch Break	
13:00 – 14:30	14:00 – 15:30	Pre-session technical and discussion forums on international collaboration (by invitation only)	6. Y.K. SHEN 7. K. TSUCHIYA 8. S.H. CHANG [†]	
14:30 – 14:45	15:30 – 15:45		Coffee & Tea Break	
14:45 – 15:30	15:45 – 16:30		9. S. AKASHI*† 10. W.C. LIN 11. I.S. HWANG [†] 12. C.C. LIN*	
15:30 – 17:00	16:30 – 18:00			
16:30 – 19:30	17:30 – 20:30	Conference Registration		



SUNDAY 08/30

- 1. Materials for thermal insulation and thermal management (R. WU)
- 2. Photoelectrochromic Devices Based on Poly(hydroxymethyl 3,4-ethylenedioxythiophene) Thin Films (C.L. LIN)
- Speech Synthesis from Articulatory Movement using Deep Neural Networks (K. KATSURADA)
- 4. Interfacial thermal management of inorganic thin films by machine learning (Y.J. WU)
- 5. Advances in Ultraprecision Micro/Nano-Machining (H. WANG)
- 6. Optimal processing of 4D printing on thermo-responsive composite material (Y.K. SHEN)
- 7. Phase Transformation in FCC High-Entropy Alloys (K. TSUCHIYA)
- 8. Real-Time Ransomware Detection in Industrial System Using Sandbox (S.H. CHANG)
- 9. Incompatibility of the ethernet frame transfer with the e-mail spoofing based on the datalink layer protocols (S. AKASHI)
- 10. Evaluation of cobalt-substituted hydroxyapatite for bone tissue engineering and clinical imaging (W.C. LIN)
- 11. Enabling SDN in Hybrid Xhaul-PON Networks for 5G (I.S. HWANG)



12. Accuracy Analyses and Clinical Applications of Stereolithographic Surgical Guide for Dental Implant Placement (C.C. LIN)

MONDAY 08/31

- 13. Study on detection of glucose solution by Surface Enhanced Raman Spectroscopy (S.C. HSU, S.W. LUO)
- 14. Thin-Film Nanocomposite Membranes Incorporated with UiO-66-NH2 Nanoparticles for Brackish Water and Seawater Desalination (D. ZHAO)
- 15. Influence of BC pretreatment on microstructure and bonding strength of 8YSZ fabricated by EB-PVD (S.H. CAI)
- 16. Corrosion Mitigation of Magnesium Alloy via Predesigned Corrosion (G.S. WU)
- 17. On the thermal diffusion conditions of electroplated Pt-diffusion bond coat for thermal barrier coatings (Z.H. XIE)